



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : **MAIL STOP: RCE**  
Yoshiyuki WADA et al. : **Confirmation No. 3411**  
Serial No. 10/684,685 : **Docket No. 2003\_1405A**  
Filed October 15, 2003 : **Group Art Unit 2811**  
SEMICONDUCTOR DEVICE AND : **Examiner N. PAREKH**  
RESIN BINDER FOR ASSEMBLING  
SEMICONDUCTOR DEVICE

**AMENDMENT AFTER FINAL**

THE COMMISSIONER IS AUTHORIZED  
TO CHARGE ANY DEFICIENCY IN THE  
FEES FOR THIS PAPER TO DEPOSIT  
ACCOUNT NO. 23-0975

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**RESPONSE UNDER 37. CFR 1.116**  
**EXPEDITED PROCEDURE**  
**EXAMINING GROUP 2811**

Sir:

Responsive to the Final Office Action mailed March 1, 2005, please amend the above-identified application as follows: